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SK 3313.230 Liquid Cooling Package

POWER DISTRIBUTION >> CLIMATE CONTROL

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IT INFRASTRUCTURE SOFTWARE & SERVICES

FRIEDHELM LOH GROUP

ENCLOSURES

SK 3313.230 - Liquid Cooling Package LCP Rack CW, LCP Rack CWG

Cooling via high-performance compact impellers. The LCP draws in the air at the sides at the rear of the server enclosures and blows the cooled air back into the front part of the server enclosure at the sides.

Features

SK 3313.230	
CW	
Maximum energy efficiency due to EC fan technology and IT-based control	
Minimal pressure loss at the air end, which in turn minimises the	
power consumption of the fans	
Control of the server inlet temperature	
With redundant temperature sensor integrated at the air end as standard	
Optimum adaptability due to dynamic, continuous control of the cold water volume flow	
By using high water inlet temperatures, the proportion of indirect free cooling is increased, which in turn reduces operating costs Targeted cooling output due to modular fan units	
	Fan modules configurable as n+1 redundancy
	Standard 3-phase connection for electrical redundancy
The separation of cooling and enclosure prevents the ingress of	
water into the server enclosure	
A footprint of max. 0.36 m ² for all cooling services	
Improved heat recovery, thanks to high water return temperatures	
when using LCP CW glycol variants, for example in combination	
with a heat pump	
Optimum access for maintenance and servicing from the front and	
rear	
Tool-free replacement of the fan modules	
The LCP draws in the air at the sides at the rear of the server	
enclosures, cools it using high-performance compact impellers, an blows the cooled air back into the front part of the server enclosure at the sides	

Features

Material	Sheet steel, spray-finished
Colour	RAL 7035
Options	Fully integrated fire detection and extinguisher system Automatic server enclosure door opening Direct connection of additional CMC III sensors is supported Racks 2200 mm high
Design	Rack cooling
Monitoring	Monitoring of all system-relevant parameters such as server air intake temperature, server waste air temperature, water inlet/return temperature, water flow, cooling output, fan speed, leakage Direct connection of the unit via SNMP over Ethernet Integration into RiZone
Total cooling output/Number of fan modules	10 kW/1 20 kW/2 30 kW/3
Air throughput (unimpeded air flow)	At 50 Hz: 4,800 m³/h
Number of fan modules in supplied state	1
Dimensions	Width: 300 mm Height: 2,000 mm Depth: 1,200 mm
To fit enclosure type	VX IT
Installation in bayed enclosure suite	Flush
Rated operating voltage	200 V - 240 V, 1~, 50 Hz/60 Hz 346 V - 415 V, 3~, 50 Hz 346 V - 415 V, 3~, 60 Hz
Max. cooling output	30 kW
Type of electrical connection	Connector
Duty cycle	100 %
Cooling medium	Water

Features

Cooling medium note	Water quality according to unit specifications.
EC fan	Yes
Fans may be exchanged with the system operational	Yes
Temperature control	Linear fan control
	Two-way control valve
Water connections	DN 40 (G 1 ¹ / ₂ " external thread)
Permissible operating pressure (p. max.)	10 bar
Water inlet temperature	15 °C
Protection category to IEC 60 529	IP 20
Options	Fully integrated fire detection and extinguisher system Automatic server enclosure door opening Direct connection of additional CMC III sensors is supported Racks 2200 mm high
Packs of	1 pc(s).
Net weight	186
Gross weight	206.5
Customs tariff number	84186900
EAN	4028177953888
ETIM 9	EC002515
ETIM 8	EC002515
ECLASS 8.0	27180712

Approvals

Explanations

Declaration of conformity